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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Re Application of

Werner PLASS et al.

Serial No.: 10/631,384

Filed: July 31, 2003

For: Surface Emitting Semiconductor Laser Chip and
Method for Producing the Chip

Examiner: SEFER, Ahmed N.
Group Art: 2826

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Rance J. Lieberman
Name of applicant, assignee or Registered Representative

Signature

August 28, 2008
Date of Signature

Mail Stop **Amendment**
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

SIR:

RESPONSE

This is in response to the Office Action dated May 29, 2008, setting a shortened statutory period for response expiring August 29, 2008. Please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 5 of this paper.